

Data Sheet

Rev. 1.00 / April 2012

ZSPM4121

Under-Voltage Load Switch for Smart Battery Management









Brief Description

The ZSPM4121 battery management load switch can be used to protect a battery from excessive discharge. It actively switches the battery power source off if it drops to a set threshold (Off Mode). When the input battery voltage is above the threshold, the load switch is on (On Mode). The ZSPM4121 threshold voltage (V_{THRESH}) is programmed at manufacturing to a set point in the range of 1.2V to 4.2V with 100mV steps between options.

When the input battery voltage has been switched off by the ZSPM4121, the quiescent current draw on the battery is in the order of 100pA (typical). The quiescent current in the on state is as low as 70nA.

The ZSPM4121 consists of an internally generated threshold voltage, a comparator with hysteresis, slew rate control for the load switch, a P-channel load switch, and an open-drain indicator pin. The 500mV hysteresis between the Off Mode and the On Mode prevents intermittent operation. The ZSPM4121 also provides over-current protection.

Benefits

- Best-in-class ultra-low quiescent current in Off Mode: 100pA (typical)
- Ultra-low quiescent current in On Mode: 70nA (typical)
- Accurate on/off voltage threshold
- Low Rds(on): 175mΩ (typical) @ 5V

Features

- Power source is actively switched off when VCC drops below a set threshold (programmed at manufacturing)
- Wide input voltage range: 1.2V to 5.5V
- Threshold voltage options of 1.2V to 4.2V in 100mV steps (factory programmed)
- Supervisory over-current limit shutdown
- · Low drop out disconnect from VCC to loads
- Controlled turn-on slew rate
- 500mV Off Mode to On Mode hysteresis
- Over current shutdown (3A)

Related ZMDI Smart Power Products

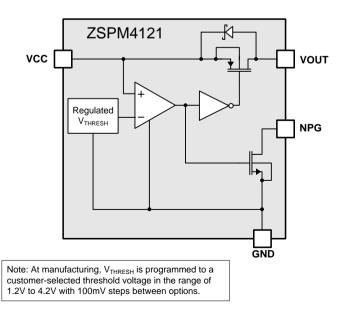
• ZSPM4141 Ultra-Low-Power Linear Regulator

Available Support

- Evaluation Kit
- Support Documentation

Physical Characteristics

• Package: 8-pin DFN (2mm x 2mm)



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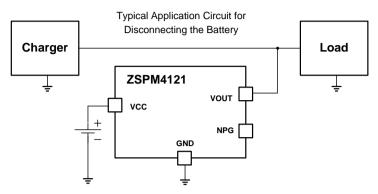
ZSPM4121 Block Diagram

Under-Voltage Load Switch for Smart Battery Management



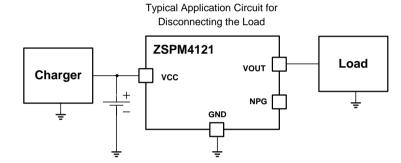


Typical Application Circuits:



Typical Applications

- Portable Batteries
- Industrial
- Medical
- Smart cards
- RFID



Ordering Information

Ordering Code*	Description	Package
ZSPM4121AI1 <i>W</i> 17	ZSPM4121 Under-Voltage Load Switch—VTHRESH factory set to 1.7V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1W21	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.1V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1W23	ZSPM4121 Under-Voltage Load Switch—VTHRESH factory set to 2.3V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1W24	ZSPM4121 Under-Voltage Load Switch—VTHRESH factory set to 2.4V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1W25	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.5V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1W26	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.6V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1W28	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.8V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1W30	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 3.0V	8-pin DFN / 7" Reel (2500)
ZSPM4121KIT	ZSPM4121 Evaluation Kit	

* X = W for 7" reel with 2500 parts or R for 13" reel with 3300. Custom V_{THRESH} values are also available: 1.2V to 4.2V (typical) in 100mV increments.

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1 ZSPM4121 Characteristics

Stresses beyond those listed under "Absolute Maximum Ratings" (section 1.1) may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those recommended under "Recommended Operating Conditions" (section 1.3) is not implied. Exposure to absolute–maximum conditions for extended periods may affect device reliability.

1.1. Absolute Maximum Ratings

Over operating free-air temperature range unless otherwise noted. All voltage values are with respect to network ground terminal.

Table 1.1 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Maximum voltage applied to the VCC, VOUT, and NPG pins		-0.3 to 6.0	V
Electrostatic Discharge – Human Body Model, according to the respective JESD22 JEDEC standard		2	kV
Operating Junction Temperature Range	TJ	-20 to 85	°C
Storage Temperature Range	T _{stg}	-65 to 150	°C
Lead Temperature (soldering, 10 seconds)		260	°C

1.2. Thermal Characteristics

Table 1.2 Thermal Characteristics for 8-Pin DFN (2mm x 2mm) Package

θ _{JA} (°C/W) ¹⁾	$\theta_{JC} (°C/W)^{2)}$
73.1	10.7
1) This rating assumes a FR4 board only.	

2) This rating assumes a 1oz. copper JEDEC standard board with thermal vias. See section 6.1 for more information.

1.3. Recommended Operating Conditions

Table 1.3 Recommended Operating Conditions

Parameter	Symbol	Min	Тур	Max	Unit
Unregulated Supply Input at VCC pin	Vcc	1.2		5.5	V
Operating Ambient Temperature ¹⁾	TA	-20		55	°C
Operating Junction Temperature	TJ	-20		85	°C
1) Operating ambient temperature is only intended as a guideline. The operating junction temperature requirements must not be exceeded.					

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1.4. Electrical Characteristics

Electrical characteristics for V_{CC} = 1.2V to 5.5 (unless otherwise noted). Minimum and maximum characteristics are tested at T_J = 25°C.

Table 1.4 Electrical Characteristics

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Input Supply	•		•	•		
Input Supply Voltage at VCC pin	Vcc		1.2		5.5	V
Quiescent Current: On Mode	I _{q-ON}	$V_{CC} = 5V$, no load		70	150	nA
Quiescent Current: Off Mode	I_{q-OFF}	V_{CC} < V_{THRESH} , no load		100		рА
Load Switch						
Over-Current Shutdown	l _{oc}	$V_{CC} = 5.0V$		3		А
Over-Current Retry Period	t _{oc}	$V_{CC} = 5.0V$		1.7		ms
Output Switch Leakage Current	I _{LEAK-SW}	V_{CC} < V_{THRESH} ; V_{OUT} grounded		100		pА
Switch ON-Resistance	Rds-on	$V_{CC} = 5.0V$		175		mΩ
		$V_{CC} = 3.3V$		200		mΩ
		V _{CC} = 1.8V		350		mΩ
Transition Times						
Transition Delay: On Mode to Off Mode	t _{d1}	$V_{OFF} = 2.0V, V_{CC} = 3.0V \rightarrow 1.5V$		650		μS
Transition Delay: Off Mode to On Mode	t _{d2}	$V_{OFF} = 2.0V, V_{CC} = 1.5V \rightarrow 3.0V$		1.7		ms
Output Turn-on Rise Time	t _{ON}	V_{CC} = 2.5V, R_{LOAD} = 50 Ω		200		μs
NPG Output						
Output Leakage	I _{LEAK-NPG}	$V_{CC} = 5.0V, V_{NPG} = 5.5V$			100	nA
Low-Level Output Voltage	Vol-NPG	I _{NPG} = 5 mA			0.4	V
Off Thresholds						
Off Threshold	Voff	V _{THRESH} = customer-selected threshold voltage in the range of 1.2V to 4.2V with 100mV steps between options programmed at manufacturing	0.95 * V _{THRESH}	V _{THRESH}	1.05 * V _{THRESH}	V
Off Mode to On Mode Hysteresis	V _{Hys}	Rising Transition: Off Mode to On Mode		500		mV

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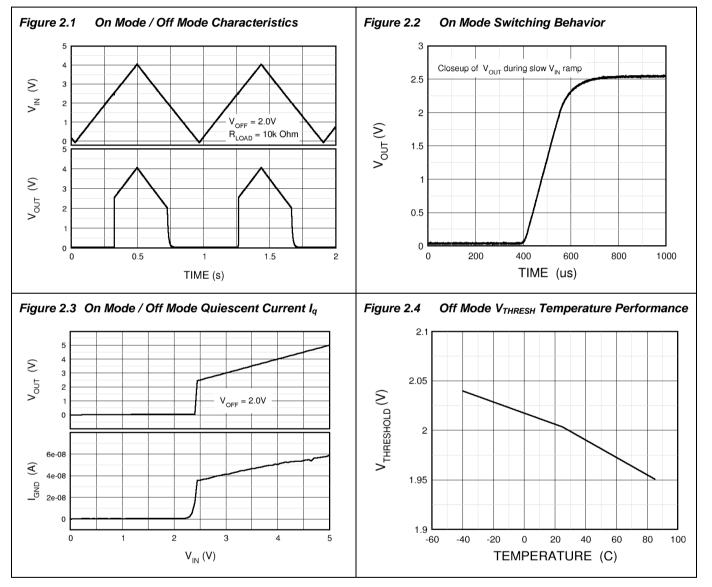
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2 Typical Performance Characteristics

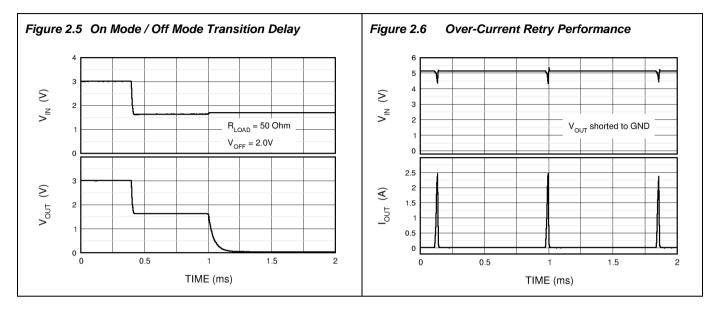
$T = 25^{\circ}C$ (unless otherwise noted)



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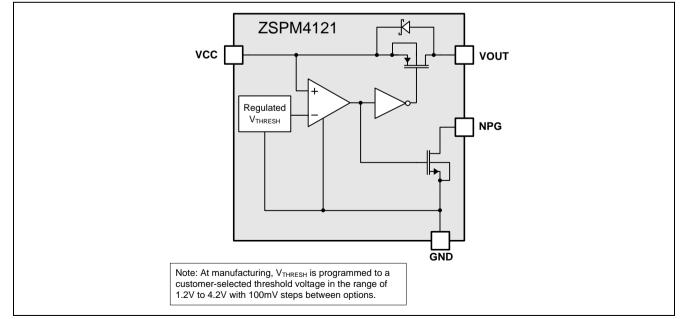




3 Description of Circuit

The ZSPM4121 battery management load switch consists of an internally generated threshold voltage, comparator with hysteresis, slew rate control for the load switch, a P-channel load switch, and an open-drain indicator pin. When the input battery voltage is above the factory-configured threshold, the load switch is on (the On Mode). When the input battery voltage falls to the threshold voltage or below, the load switch is off (the Off Mode), and the quiescent current draw on the battery is in the order of 100pA (typical). The ZSPM4121 threshold voltage is programmed at manufacturing to an option in the range of 1.2V to 4.2V with 100mV steps between options. The 500mV hysteresis between the Off Mode and the On Mode prevents intermittent operation. The ZSPM4121 also provides over-current protection.





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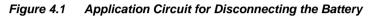




4 Application Circuits

4.1. Typical Application Circuits

Note that when the ZSPM4121 is in Off Mode, the battery will continue to charge through the body diode between VOUT and VCC for the application shown in Figure 4.1.



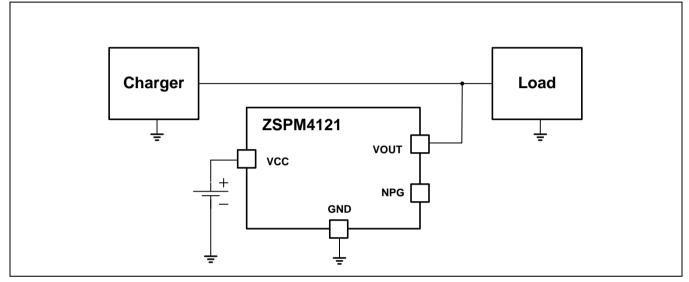
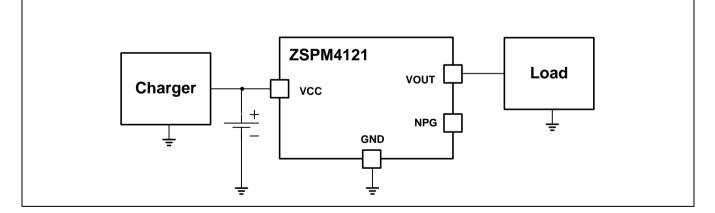


Figure 4.2 Application Circuit for Disconnecting the Load



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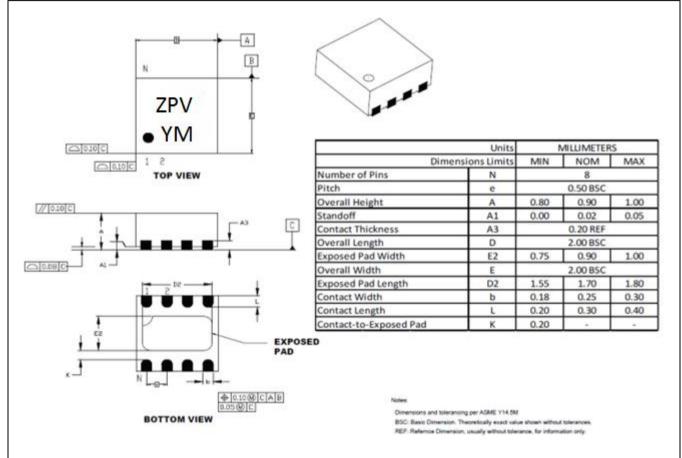




5 Pin Configuration and Package

5.1. Package Dimensions and Marking Diagram

Figure 5.1 ZSPM4121 Package Drawing



MARKING CODES:

- Z: ZMDI
- P: Product Code
- V: Voltage levels: 1 = 1.2V, 2 = 1.3V, 3 = 1.4V, 4 = 1.5V, 5 = 1.6V, 6 = 1.7V, 7 = 1.8V. 8 = 1.9V, 9 = 2.0V, A = 2.1 V, B = 2.2 V, C = 2.3 V, D = 2.4 V, E V = 2.5V to 4.2V
- **YM:** Date Code (Year, Month)

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5.2. Pin Description for 8-Pin DFN (2x2 mm)

Figure 5.2 ZSPM4121 Pin Assignments (top view)

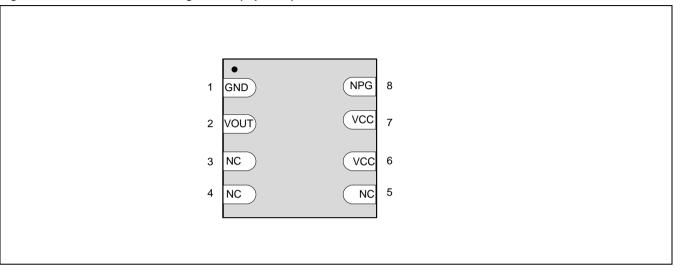


Table 5.1: Pin Description, 8-Pin DFN (2x2)

Pin #	Name	Function	Description	
1	GND	Ground	GND	
2	V _{OUT}	Output	Output Output to System Load	
3	NC		No Connection (connect to GND or float)	
4	NC		No Connection (connect to GND or float)	
5	NC		No Connection (connect to GND or float)	
6	VCC	Supply	Supply Input (connect to pin 7 and VCC supply rail)	
7	VCC	Supply	Supply Input (connect to pin 6 and VCC supply rail)	
8	NPG	Output	Open-Drain N-Channel Output (low indicates "Power Good")	

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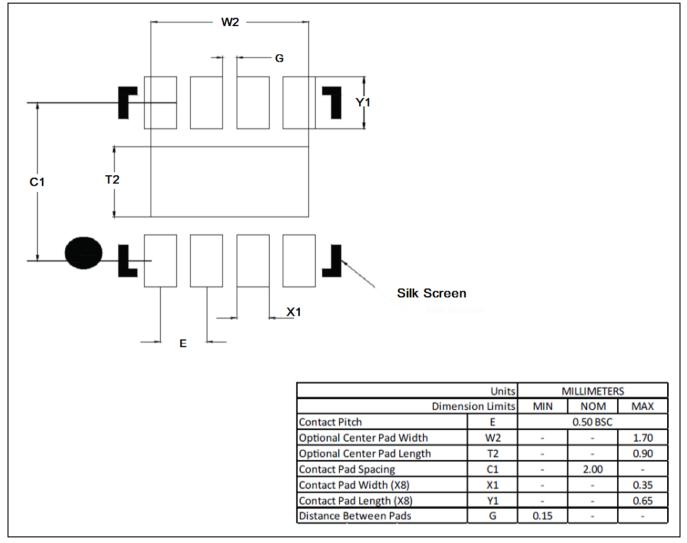


6 Layout and Soldering Requirements

To maximize the efficiency of this package for applications on a single layer or multi-layer printed circuit board (PCB), certain guidelines must be followed when laying out this part on the PCB.

6.1. Recommended Landing Pattern for PCBs

Figure 6.1 Recommended Landing Pattern for 8-Pin DFN



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6.2. Multi-Layer PCB Layout

The following are guidelines for mounting the exposed pad ZSPM4121 on a multi-Layer PCB with ground a plane. In a multi-layer board application, the thermal vias are the primary method of heat transfer from the package thermal pad to the internal ground plane. The efficiency of this method depends on several factors, including die area, number of thermal vias, and thickness of copper, etc.

Figure 6.2 Package and PCB Land Configuration for Multi-Layer PCB

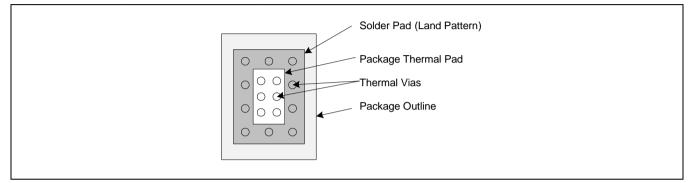


Figure 6.3 JEDEC Standard FR4 Multi-Layer Board – Cross-Sectional View

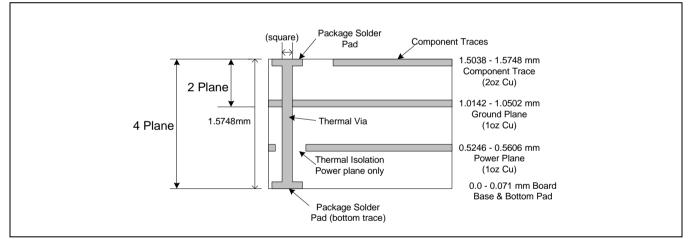


Figure 6.4 is a representation of how the heat can be conducted away from the die using an exposed pad package. Each application will have different requirements and limitations, and therefore the user should use sufficient copper to dissipate the power in the system. The output current rating for the linear regulators might need to be de-rated for ambient temperatures above 85°C. The de-rated value will depend on calculated worst case power dissipation and the thermal management implementation in the application.

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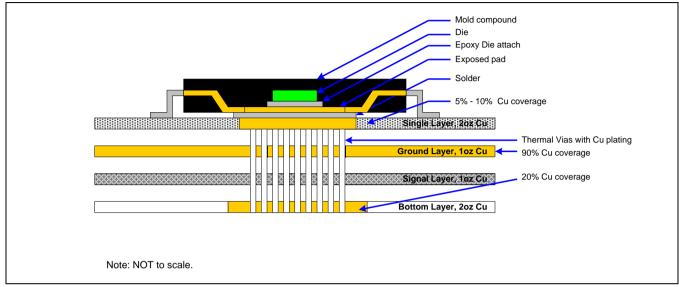


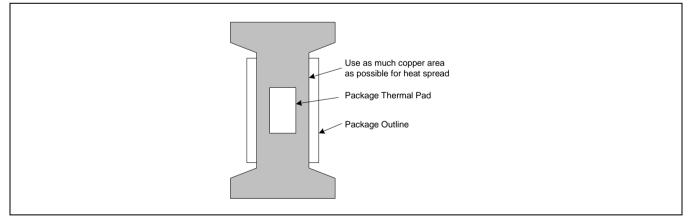
Figure 6.4 Conducting Heat Away from the Die using an Exposed Pad Package

6.3. Single-Layer PCB Layout

Layout recommendations for a single-layer PCB: Utilize as much copper area for power management as possible. In a single-layer board application, the thermal pad is attached to a heat spreader (copper areas) by using a low thermal impedance attachment method (solder paste or thermal conductive epoxy).

In both of the methods mentioned above, it is advisable to use as much copper trace as possible to dissipate the heat.





Important: If the attachment method is NOT implemented correctly, the functionality of the product is NOT guaranteed. Power dissipation capability will be adversely affected if the device is incorrectly mounted onto the circuit board.

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7 Ordering Information

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ZSPM4121AI1 <i>W</i> 23	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.3V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 24	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.4V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 25	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.5V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 26	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.6V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 28	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.8V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 30	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 3.0V	8-pin DFN / 7" Reel (2500)
ZSPM4121KIT	ZSPM4121 Evaluation Kit	

* Custom values are also available in the range of 1.2V - 4.2V (typical) in 100mV increments.

8 Related Documents

Document	File Name
ZSPM4121 Feature Sheet	ZSPM4121_Feature_Sheet_revX_xy.pdf
ZSPM4121 Evaluation Kit Description	ZSPM4121_Eval_Kit_Description_revX_xy.pdf
ZSPM4121 Application Note—Low Power Battery Control and Voltage Regulator Solutions for Remote Sensor Networks	ZSPM4121_App_Note_LP-Batt-Contr-VReg-Remote-Sensor-Net_X_xy.pdf

Note: X_xy refers to the current revision of the document.

Visit ZMDI's website www.zmdi.com or contact your nearest sales office for the latest version of these documents.

9 Glossary

Term	Description	
PG	ower Good (NPG = Power Good, active low)	
RFID	adio Frequency Identification	
SPM	Smart Power Management	

10 Document Revision History

Revision	Date	Description
1.00	April 30, 2012	First release

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